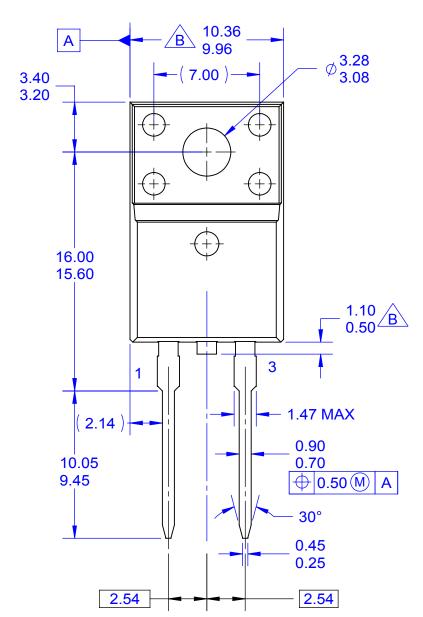
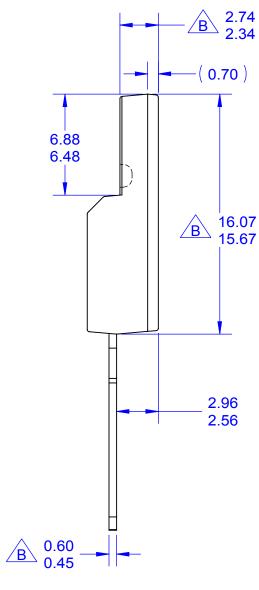
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REVISIONS							
NBR	DESCRIPTION	DATE	BY/APP'D				
1	RELEASED TO DCC	08JUL08	H.ALLEN.FSME				
2	COMPLETE REDRAW	14APR09	KH LEE/ SUZHOU				





## NOTES:

4.90

4.50

/B

- A. EXCEPT WHERE NOTED CONFORMS TO  $_{\wedge}$   $\,$  EIAJ SC91A.
- B DOES NOT COMPLY EIAJ STD. VALUE.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- E. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
- F. DRAWING FILE NAME: TO220C02REV2

APPROVALS	DATE					
DRAWN: BOBOY MALDO	14APR09	FAIRCHILD				
CHECKED: KH LEE		SEMICONDUCTOR 114				
APPROVED: BY HUANG		2LD, TO220,				
APPROVED: HOWARD ALLEN		MOLDED, FULL PACK				
PROJECTION .		SCALE	SIZE	DRAWING NUMBI		REV
PROJECTION		1:1	N/A	MKT-TO	220C02	2
[MM] INCH		FORMERLY: N/A		SHEET: 1 OF 1		